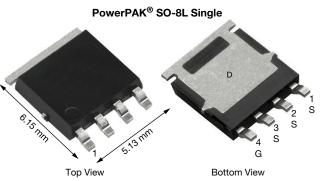
SIJ4409DP

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PRODUCT SUMMARY -40 V_{DS} (V) $R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V 0.0096 $R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V 0.0125 Q_q typ. (nC) 38.1 I_D (A) a -43.6 Configuration Single

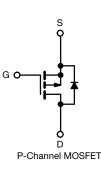
FEATURES

P-Channel 40 V (D-S) MOSFET

- New generation p-channel power MOSFET
- Ultra low R_{DS} x Q_g FOM product
- 100 % R_q and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Battery and circuit protection
- · Load switch
- Motor drive control



RoHS COMPLIANT

HALOGEN

FREE

ORDERING INFORMATION

Package	PowerPAK [®] SO-8L
Lead (Pb)-free and halogen-free	SIJ4409DP-T1-GE3

ABSOLUTE MAXIMUM RATING	iS (T _A = 25 °C, ι	Inless otherw	ise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-40	V	
Gate-source voltage		V _{GS}	± 20	v	
	T _C = 25 °C		-43.6		
Continuous drain current (T _J = 150 °C)	T _C = 70 °C	Τ.Γ	-34.9		
	T _A = 25 °C		-15.5 ^{b, c}		
	T _A = 70 °C	T	-12.4 ^{b, c}	•	
Pulsed drain current (t = 100 µs)		I _{DM}	-200	— A	
	T _C = 25 °C		-29.9		
Continuous source-drain diode current	T _A = 25 °C	I _S	-3.8 ^{b, c}		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	-30		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	45	mJ	
	T _C = 25 °C		32.8		
	T _C = 70 °C		21.0		
Maximum power dissipation	T _A = 25 °C	P _D	2.6 ^{b, c}	W	
	T _A = 70 °C	T	1.7 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	*0	
Soldering recommendations (peak temperature) d			260		

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^b	t ≤ 10 s	R _{thJA}	24	30	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	3.0	3.8	C/W

Notes

T_C = 25 °C a.

Surface mounted on 1" x 1" FR4 board b.

t = 10 s c.

See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection d.

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 70 °C/W e. f.

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	V_{GS} = 0 V, I_D = -250 μ A	-40	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = -1 mA	-	-34	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	4.3	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-1.0	-	-2.3	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = +20 \text{ / } -20 \text{ V}$	-	-	100	nA	
Zero gate voltage drain current		$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1		
	I _{DSS}	V_{DS} = -40 V, V_{GS} = 0 V, T_{J} = 70 °C	-	-	-10	μA	
Drain actures an atota registerias à	P	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -15 \text{ A}$	-	0.0079	0.0096	Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -15 \text{ A}$	-	0.010	0.0122		
Forward transconductance a	9 _{fs}	V _{DS} = -15 V, I _D = -15 A	-	58	-	S	
Dynamic ^b			•	•	•	•	
Input capacitance	C _{iss}		-	5670	-		
Output capacitance	C _{oss}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	345	-	pF	
Reverse transfer capacitance	C _{rss}		-	330	-		
		V_{DS} = -20 V, V_{GS} = -10 V, I_{D} = -15 A	-	84	126	- nC	
Total gate charge	Qg		-	38.1	58		
Gate-source charge	Q _{gs}	V_{DS} = -20 V, V_{GS} = -4.5 V, I_{D} = -15 A	-	14	-		
Gate-drain charge	Q _{gd}		-	12.2	-		
Gate resistance	R _g	f = 1 MHz	1.0	2.2	4.0	Ω	
Turn-on delay time	t _{d(on)}		-	12	24		
Rise time	tr	$V_{DD} = -20 \text{ V}, \text{ R}_{\text{I}} = 2 \Omega, \text{ I}_{\text{D}} \cong -10 \text{ A},$	-	5	10	-	
Turn-off delay time	t _{d(off)}	V_{GEN} = -10 V, R_{g} = 1 Ω	-	50	100		
Fall time	t _f		-	9	18		
Turn-on delay time	t _{d(on)}		-	31	62	ns	
Rise time	t _r	$V_{DD} = -20 \text{ V}, \text{ R}_{L} = 2 \Omega, \text{ I}_{D} \cong -10 \text{ A},$	-	56	112		
Turn-off delay time	t _{d(off)}	V_{GEN} = -4.5 V, R_g = 1 Ω	-	41	82		
Fall time	t _f		-	23	46		
Drain-Source Body Diode Characterist	cs						
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-49.6	•	
Pulse diode forward current	I _{SM}		-	-	-200	A	
Body diode voltage	V _{SD}	$I_{\rm S} = -5$ A, $V_{\rm GS} = 0$ V	-	-0.75	-1.2	V	
Body diode reverse recovery time	t _{rr}		-	19	38	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = -10 A, di/dt = 100 A/µs,	-	12	24	nC	
Reverse recovery fall time	t _a	$T_J = 25 \ ^{\circ}C$	-	11	-		
Reverse recovery rise time	t _b		-	8	-	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

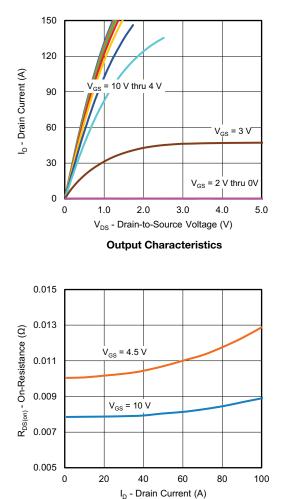
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

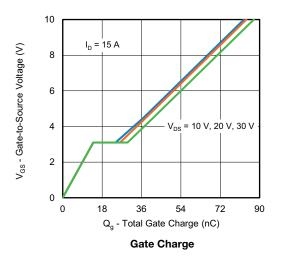
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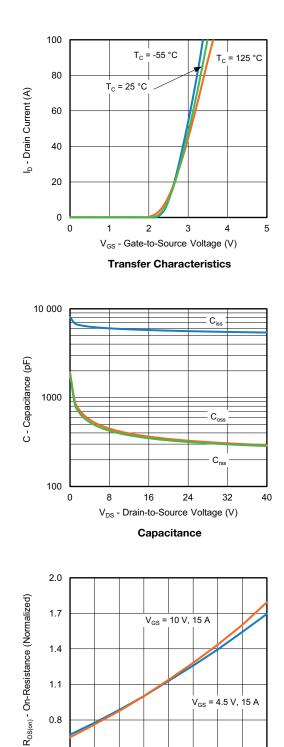


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



On-Resistance vs. Drain Current and Gate Voltage





0.5 -50 -25 0 25 50 75 100 125 150 T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

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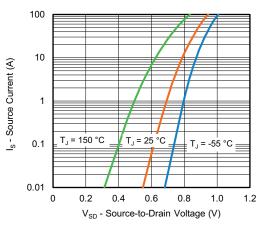
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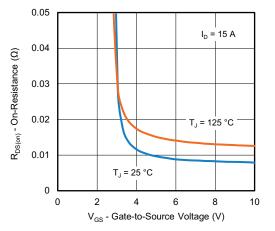
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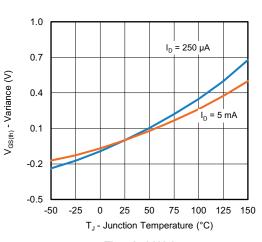
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



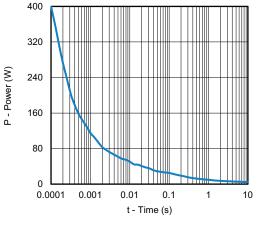
Source-Drain Diode Forward Voltage



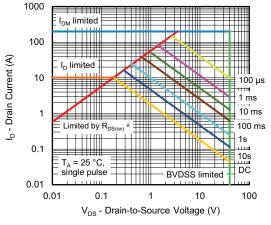
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

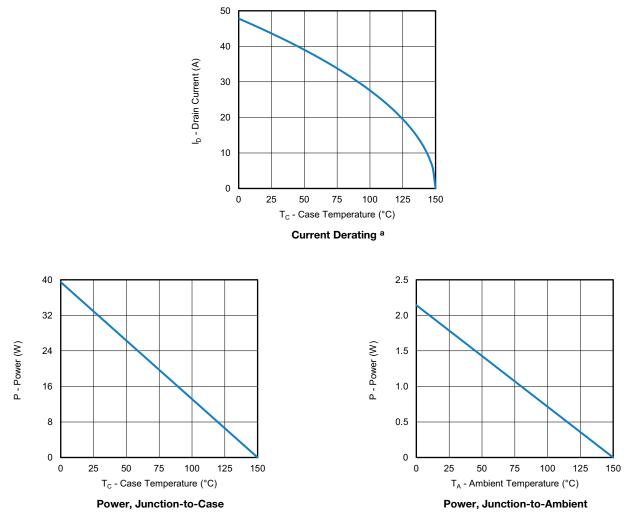
Note

a. V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

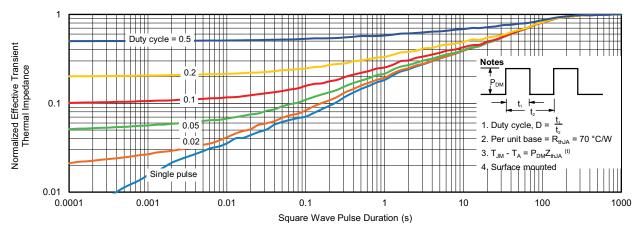
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



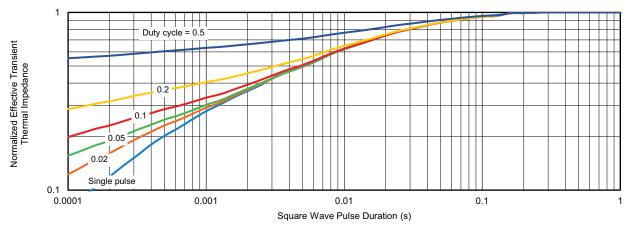
SIJ4409DP

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62490.

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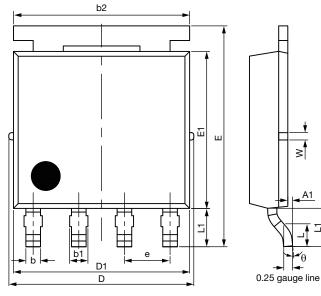


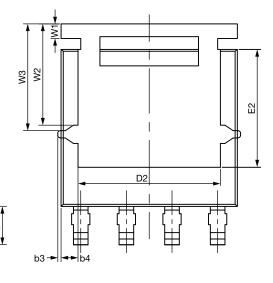


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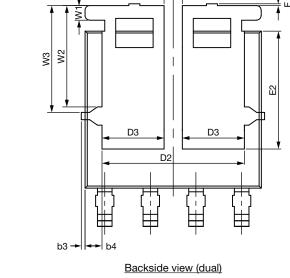
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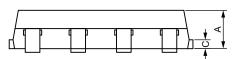




Topside view

Backside view (single)





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Package Information



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DIM	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN. NOM.		MAX.	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094			0.004		
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC		0.050 BSC			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	3.18	3.28	3.38	0.125	0.129	0.133	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
К		0.51			0.020		
W		0.23			0.009		
W1	0.41			0.016			
W2	2.82			0.111			
W3	2.96			0.117			
θ	0°	-	10°	0°	-	10°	

Note

• Millimeters will gover



RECOMMENDED MINIMUM PAD FOR PowerPAK[®] SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)

Revision: 07-Feb-12



Vishay

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